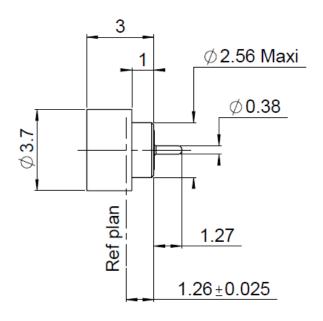


Technical Data Sheet

HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

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All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (μm)
Body	DILVER P1	GOLD OVER NICKEL
Center contact Outer contact	DILVER P1	GOLD OVER NICKEL
Insulator	GLASS	
Gasket		
Others parts		
-	-	-
-	-	-



Technical Data Sheet

HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

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17.02 270	10002 21 12 102	OLIVILO OMI	FAILT NOWIDER N222043020

PACKAGING

100	Contact us	Contact us
Standard	Unit	Other

ELECTRICAL CHARACTERISTICS

Impedance 50 Ω Frequency 0-40 GHz

x F(GHz) Maxi √F(GHz) dB Maxi VSWR 1.15* 0.0000 Insertion loss 0.12 - F(GHz)) dB Maxi RF leakage - (Voltage rating 335 Veff Maxi Dielectric withstanding voltage 500 Veff mini Insulation resistance 5000 $M\Omega$ mini

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating End
Axial force – Opposite end
Torque

6.8 N mini
N mini
N.cm mini

Recommended torque

Mating N.cm Panel nut N.cm

Mating life 100 Cycles mini Weight 0.0800 g

ENVIRONMENTAL

Operating temperature -65/+165 °C Hermetic seal 10-8 Atm.cm3/s Panel leakage

SPECIFICATION

OTHER CHARACTERISTICS

Assembly instruction:

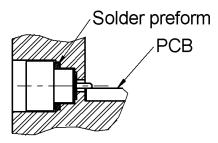
Others: * to 18GHz





HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

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- 1. Degrease and clean connector and box
- 2. Solder the connector on the panel we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C. Take care not to exceed 260°C during solder operation
- 3. Solder the pin on the track we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C (only for ceramic substrate). Take care not to exceed 260°C during solder operation

